TEXAS INSTRUMENTS

TPS3852-Q1
JAJSCZ7 – FEBRUARY 2017

TPS3852-Q1 高精度電圧スーパバイザ、ウォッチドッグ・タイマ内蔵

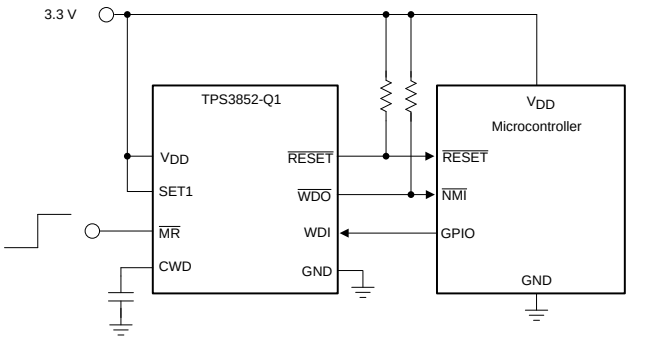
1 特長

- 下記内容でAEC-Q100認定済み
  - デバイス温度グレード1: 動作時周囲温度範囲 –40°C～125°C
  - デバイスHBM ESD分類レベル2
  - デバイスCDM ESD分類レベルC4B
- V_{DD}入力電圧範囲: 1.6V～6.5V
- 0.8%の電圧スレッショルド精度
- 低い消費電流: I_{DD} =10µA (標準値)
- ウォッチドッグのタイムアウトをユーザーがプログラム可能
- 工場でプログラム済みの高精度のウォッチドッグとリセット・タイマ
  - ±15%精度のWDTおよびRST遅延
- オープン・ドレイン出力
- マニュアル・リセット入力(MR)
- 高精度の電圧監視
  - 1.8V～5.0Vの共通レールをサポート
  - 4%および7%のスレッショルドを利用可能
  - 0.5%のヒステリシス
- ウォッチドッグのディセーブル機能
- 3mm×3mmの小型8ピンVSONパッケージで供給

2 アプリケーション

- 安全性が重要なアプリケーション
- 車載用視覚情報システム
- 車載用ADASシステム
- テレマティクス制御ユニット
- FPGAおよびASIC
- マイクロコントローラおよびDSP

代表的なアプリケーション回路



3 概要

TPS3852-Q1は高精度の電圧スーパバイザで、ウィンドウ・ウォッチドッグ・タイマが内蔵されています。TPS3852-Q1には高精度の低電圧スーパバイザが内蔵されており、低電圧スレッショルド(V_{ITN})は-40℃～+125℃の規定の温度範囲全体にわたって0.8%の精度を実現しています。さらに、TPS3852-Q1には正確なヒステリシスが含まれているため、このデバイスは許容範囲の狭いシステムでの使用に理想的です。スーパバイザのRESET遅延は、高精度の遅延タイマにより15%精度を実現しています。

TPS3852-Q1にはプログラム可能なウィンドウ・ウォッチドッグ・タイマが内蔵されており、広範なアプリケーションに使用できます。専用ウォッチドッグ出力(WDO)により分解能が向上し、フォルト状況の性質を判定するために役立ちます。ウォッチドッグのタイムアウトは、外付けのコンデンサ、または工場でプログラムされるデフォルトの遅延設定によりプログラム可能です。ウォッチドッグはディセーブル可能で、開発プロセスにおいて望ましくないウォッチドッグのタイムアウトを回避できます。

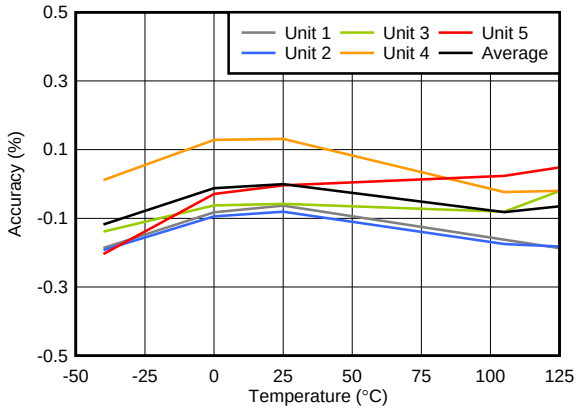
TPS3852-Q1は、小型の3.00mm×3.00mm、8ピンのVSONパッケージで供給されます。TPS3852-Q1はウェッタブル・フランクを採用し、光学検査を容易に行えます。

製品情報(1)

型番	パッケージ	本体サイズ(公称)
TPS3852-Q1	VSON (8)	3.00mm×3.00mm

(1) 提供されているすべてのパッケージについては、データシートの末尾にある注文情報を参照してください。

低電圧スレッショルド(V_{ITN})の精度と温度との関係



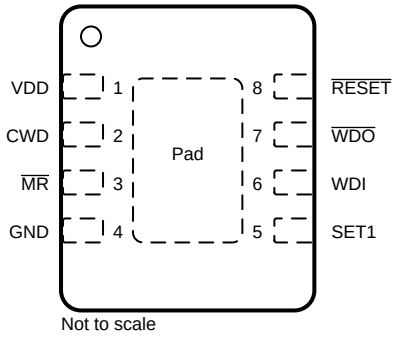
目次

4 改訂履歴

日付	改訂内容	注
2017年2月	*	初版

5 Pin Configuration and Functions

DRB Package
8-Pin VSON
Top View



Not to scale

Pin Functions

NAME	NO.	I/O	DESCRIPTION
CWD	2	—	Programmable watchdog timeout input. Watchdog timeout is set by connecting a capacitor between this pin and ground. Furthermore, this pin can also be connected by a 10-kΩ resistor to VDD, or leaving unconnected (NC) further enables the selection of the preset watchdog timeouts; see the *Timing Requirements* table. When using a capacitor, the TPS3852-Q1 determines the window watchdog upper boundary with 式 1. See 表 4 and the *CWD Functionality* section for additional information.
GND	4	—	Ground pin
$\overline{MR}$	3	I	Manual reset pin. A logical low on this pin issues a $\overline{RESET}$. This pin is internally pulled up to V_{DD}. $\overline{RESET}$ remains low for a fixed reset delay (t_{RST}) time after $\overline{MR}$ is deasserted (high).
$\overline{RESET}$	8	O	Reset output. Connect $\overline{RESET}$ using a 1-kΩ to 100-kΩ resistor to the desired pullup voltage rail (V_{PU}). $\overline{RESET}$ goes low when V_{DD} goes below the undervoltage threshold (V_{ITN}). When V_{DD} is within the normal operating range, the $\overline{RESET}$ timeout counter starts. At completion, $\overline{RESET}$ goes high. During startup, the state of $\overline{RESET}$ is undefined below the specified power-on-reset (POR) voltage (V_{POR}). Above POR, $\overline{RESET}$ goes low and remains low until the monitored voltage is within the correct operating range (above $V_{ITN} + V_{HYST}$) and the $\overline{RESET}$ timeout is complete.
SET1	5	I	Logic input. Grounding the SET1 pin disables the watchdog timer.
VDD	1	I	Supply voltage pin. For noisy systems, connecting a 0.1-µF bypass capacitor is recommended.
WDI	6	I	Watchdog input. A falling transition (edge) must occur at this pin between the lower ($t_{WDL(max)}$) and upper ($t_{WDU(min)}$) window boundaries in order for $\overline{WDO}$ to not assert. When the watchdog is not in use, the SET1 pin can be used to disable the watchdog. The input at WDI is ignored when $\overline{RESET}$ or $\overline{WDO}$ are low (asserted) and also when the watchdog is disabled. If the watchdog is disabled, then WDI cannot be left unconnected and must be driven to either VDD or GND.
$\overline{WDO}$	7	O	Watchdog output. Connect $\overline{WDO}$ with a 1-kΩ to 100-kΩ resistor to the desired pullup voltage rail (V_{PU}). $\overline{WDO}$ goes low (asserts) when a watchdog timeout occurs. $\overline{WDO}$ only asserts when $\overline{RESET}$ is high. When a watchdog timeout occurs, $\overline{WDO}$ goes low (asserts) for the set $\overline{RESET}$ timeout delay (t_{RST}). When $\overline{RESET}$ goes low, $\overline{WDO}$ is in a high-impedance state.
Thermal pad		—	Connect the thermal pad to a large-area ground plane. The thermal pad is internally connected to GND.

6 Specifications

6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)(1)

		MIN	MAX	UNIT
Supply voltage range	VDD	–0.3	7	V
Output voltage range	$\overline{\text{RESET}}$, $\overline{\text{WDO}}$	–0.3	7	V
Voltage ranges	SET1, WDI, $\overline{\text{MR}}$	–0.3	7	V
	CWD, CRST	–0.3	V_{DD} + 0.3(2)	
Output pin current			±20	mA
Input current (all pins)			±20	mA
Continuous total power dissipation		See *Thermal Information*		
Temperature	Operating junction, T_J(3)	–40	150	°C
	Operating free-air, T_A(3)	–40	150	
	Storage, T_{stg}	–65	150	

(1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
(2) The absolute maximum rating is V_{DD} + 0.3 V or 7.0 V, whichever is smaller.
(3) Assume that $T_J = T_A$ as a result of the low dissipated power in this device.

6.2 ESD Ratings

			VALUE	UNIT
$V_{(ESD)}$	Electrostatic discharge	Human-body model (HBM), per AEC Q100-002(1)	±2000	V
		Charged-device model (CDM), per AEC Q100-011	±750	

(1) AEC Q100-002 indicates that HBM stressing shall be in accordance with the ANSI/ESDA/JEDEC JS-001 specification.

6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

		MIN	NOM	MAX	UNIT
V_{DD}	Supply pin voltage	1.6		6.5	V
V_{SET1}	SET1 pin voltage	0		6.5	V
$V_{\overline{MR}}$	MR pin voltage	0		6.5	V
C_{CWD}	Watchdog timing capacitor	0.1(1)		1000(1)	nF
CWD	Pullup resistor to VDD	9	10	11	kΩ
R_{PU}	Pullup resistor, $\overline{\text{RESET}}$ and $\overline{\text{WDO}}$	1	10	100	kΩ
$I_{\overline{RESET}}$	$\overline{\text{RESET}}$ pin current			10	mA
$I_{\overline{WDO}}$	Watchdog output current			10	mA
T_J	Junction temperature	–40		125	°C

(1) Using a C_{CWD} capacitor of 0.1 nF or 1000 nF gives a $t_{WDU(typ)}$ of 62.74 ms or 77.45 seconds, respectively.

6.4 Thermal Information

THERMAL METRIC(1)		TPS3852-Q1 DRB (VSON) 8 PINS	UNIT
$R_{\theta JA}$	Junction-to-ambient thermal resistance	47.7	°C/W
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	51.5	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	22.2	°C/W
ψ_{JT}	Junction-to-top characterization parameter	1.3	°C/W
ψ_{JB}	Junction-to-board characterization parameter	22.3	°C/W
$R_{\theta JC(bot)}$	Junction-to-case (bottom) thermal resistance	4.3	°C/W

(1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application report.

6.5 Electrical Characteristics

at $V_{ITN} + V_{HYST} \le V_{DD} \le 6.5$ V over the operating temperature range of –40°C ≤ T_A, T_J ≤ +125°C (unless otherwise noted); the open-drain pullup resistors are 10 kΩ for each output; typical values are at T_J = 25°C

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
GENERAL CHARACTERISTICS						
V_{DD}(1)	Supply voltage		1.6		6.5	V
I_{DD}	Supply current			10	19	µA
RESET FUNCTION						
V_{POR}(2)	Power-on-reset voltage	$I_{\overline{RESET}}$ = 15 µA, $V_{OL(MAX)}$ = 0.25 V			0.8	V
V_{UVLO}(3)	Undervoltage lockout voltage			1.35		V
V_{ITN}	Undervoltage threshold accuracy, entering $\overline{RESET}$	V_{DD} falling	V_{ITN} – 0.8%		V_{ITN} + 0.8%	
V_{HYST}	Hysteresis voltage	V_{DD} rising	0.2%	0.5%	0.8%	
$I_{\overline{MR}}$	$\overline{MR}$ pin internal pullup current	$V_{\overline{MR}}$ = 0 V	500	620	700	nA
WINDOW WATCHDOG FUNCTION						
I_{CWD}	CWD pin charge current	CWD = 0.5 V	337	375	413	nA
V_{CWD}	CWD pin threshold voltage		1.192	1.21	1.228	V
V_{OL}	$\overline{RESET}$, $\overline{WDO}$ output low	VDD = 5 V, $I_{\overline{RESET}}$ = $I_{\overline{WDO}}$ = 3 mA			0.4	V
I_D	$\overline{RESET}$, $\overline{WDO}$ output leakage current, open-drain	VDD = V_{ITN} + V_{HYST}, $V_{\overline{RESET}}$ = $V_{\overline{WDO}}$ = 6.5 V			1	µA
V_{IL}	Low-level input voltage ($\overline{MR}$, SET1)				0.25	V
V_{IH}	High-level input voltage ($\overline{MR}$, SET1)		0.8			V
$V_{IL(WDI)}$	Low-level input voltage (WDI)				0.3 × V_{DD}	V
$V_{IH(WDI)}$	High-level input voltage (WDI)		0.8 × V_{DD}			V

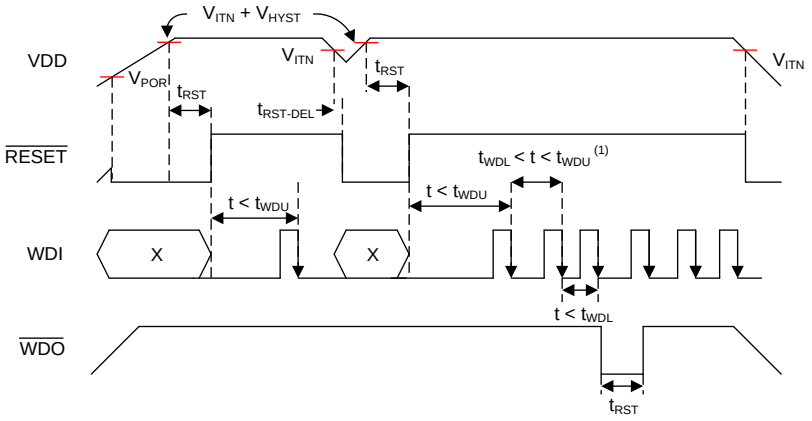
(1) During power on, V_{DD} must be a minimum of 1.6 V for at least 300 µs before $\overline{RESET}$ correlates with V_{DD}.
(2) When V_{DD} falls below V_{POR}, $\overline{RESET}$ and $\overline{WDO}$ are undefined.
(3) When V_{DD} falls below UVLO, $\overline{RESET}$ is driven low.

6.6 Timing Requirements

at $V_{ITN} + V_{HYST} \le V_{DD} \le 6.5$ V over the operating temperature range of –40°C ≤ T_A, T_J ≤ +125°C (unless otherwise noted); the open-drain pullup resistors are 10 kΩ for each output; typical values are at T_J = 25°C

			MIN	TYP	MAX	UNIT
GENERAL						
t_{INIT}	CWD pin evaluation period			381		µs
	Minimum $\overline{MR}$, SET1 pin pulse duration			1		µs
	Startup delay			300		µs
RESET FUNCTION						
t_{RST}	Reset timeout period		170	200	230	ms
$t_{RST-DEL}$	V_{DD} to $\overline{RESET}$ delay	$V_{DD} = V_{ITN} + V_{HYST}$ + 2.5%		35		µs
		$V_{DD} = V_{ITN}$ – 2.5%		17		
t_{MR-DEL}	$\overline{MR}$ to $\overline{RESET}$ delay			200		ns
Watchdog Function						
t_{WDL}	Window watchdog lower boundary	CWD = NC, SET1 = 0 (1)		Watchdog disabled		
		CWD = NC, SET1 = 1 (1)	680	800	920	ms
		CWD = 10 kΩ to VDD, SET1 = 0 (1)		Watchdog disabled		
		CWD = 10 kΩ to VDD, SET1 = 1 (1)	1.48	1.85	2.22	ms
t_{WDU}	Window watchdog upper boundary	CWD = NC, SET1 = 0 (1)		Watchdog disabled		
		CWD = NC, SET1 = 1 (1)	1360	1600	1840	ms
		CWD = 10 kΩ to VDD, SET1 = 0 (1)		Watchdog disabled		
		CWD = 10 kΩ to VDD, SET1 = 1 (1)	9.35	11.0	12.65	ms
$t_{WD-setup}$	Setup time required for device to respond to changes on WDI after being enabled			150		µs
	Minimum WDI pulse duration			50		ns
t_{WD-DEL}	WDI to $\overline{WDO}$ delay			50		ns

(1) SET1 = 0 means $V_{SET1} < V_{IL}$, SET1 = 1 means $V_{SET1} > V_{IH}$.



(1) See 図 2 for WDI timing requirements.

図 1. Timing Diagram

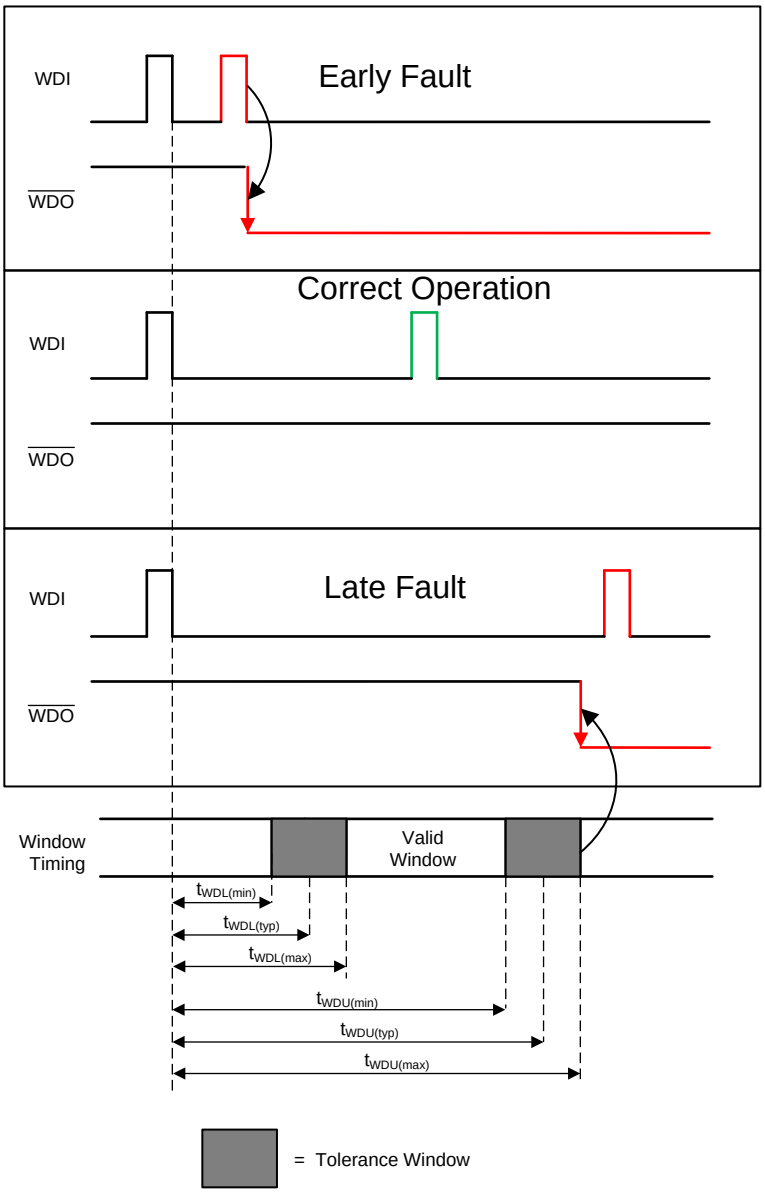


図 2. TPS3852-Q1 Window Watchdog Timing

6.7 Typical Characteristics

all curves are taken at 25°C with 1.6 V ≤ VDD ≤ 6.5 V (unless otherwise noted)

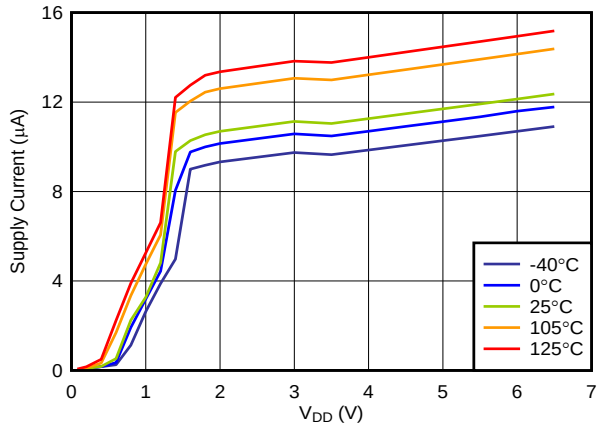
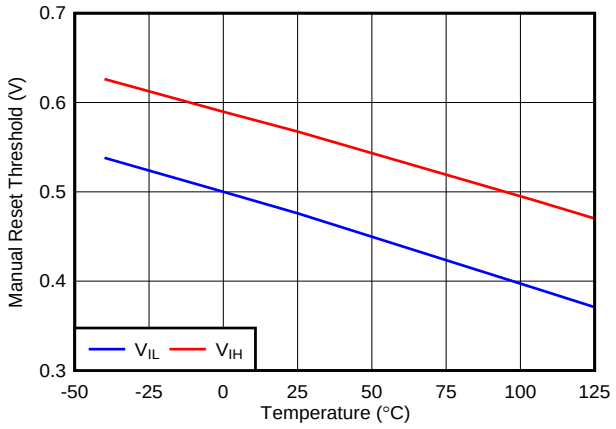


図 3. Supply Current vs V_{DD}



VDD = 1.6 V

図 4. $\overline{MR}$ Threshold vs Temperature

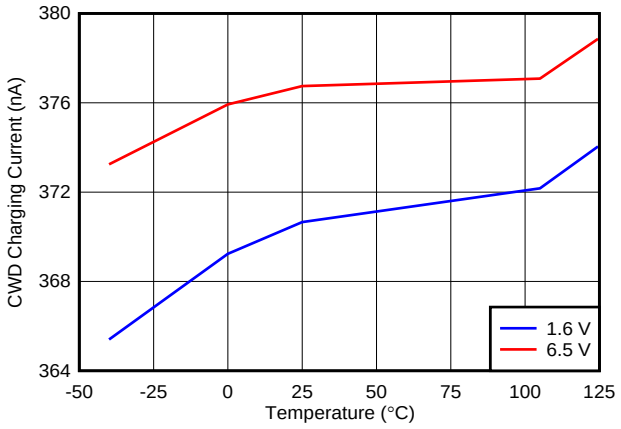
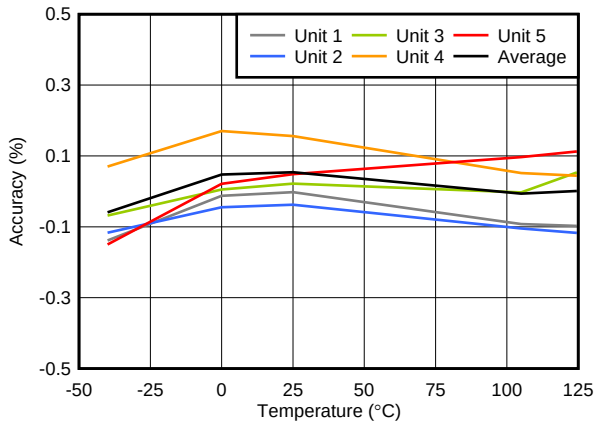
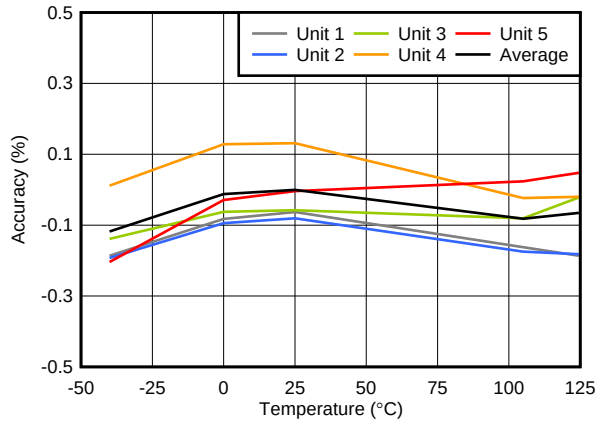


図 5. CWD Charging Current vs Temperature



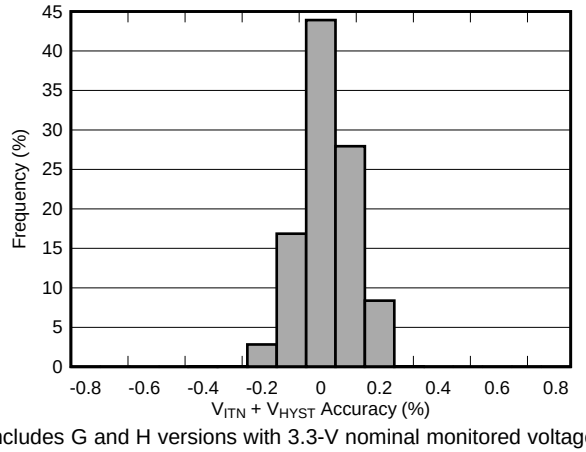
TPS3852G33-Q1

図 6. V_{ITN} + V_{HYST} Accuracy vs Temperature



TPS3852G33-Q1

図 7. V_{ITN} Accuracy vs Temperature

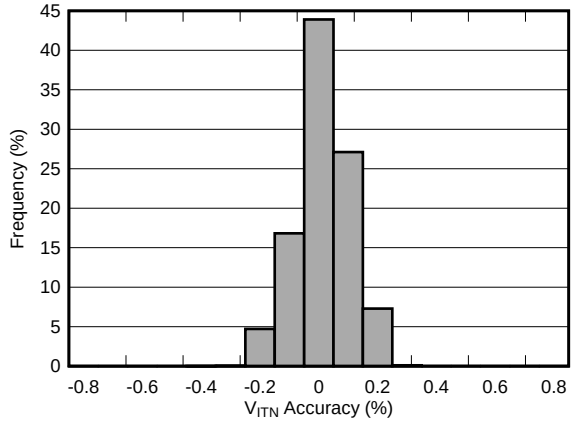


Includes G and H versions with 3.3-V nominal monitored voltage, total units = 15,536

図 8. V_{ITN} + V_{HYST} Accuracy Histogram

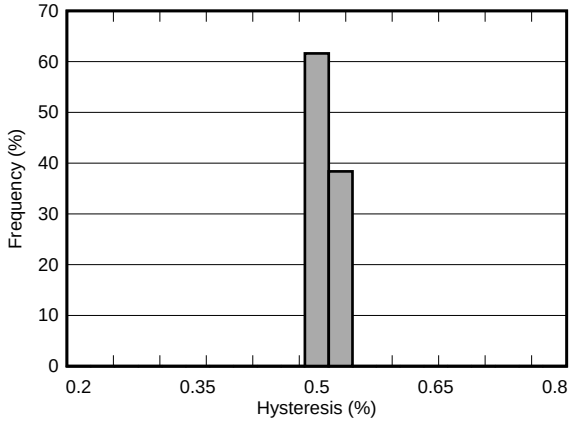
Typical Characteristics (continued)

all curves are taken at 25°C with 1.6 V ≤ VDD ≤ 6.5 V (unless otherwise noted)



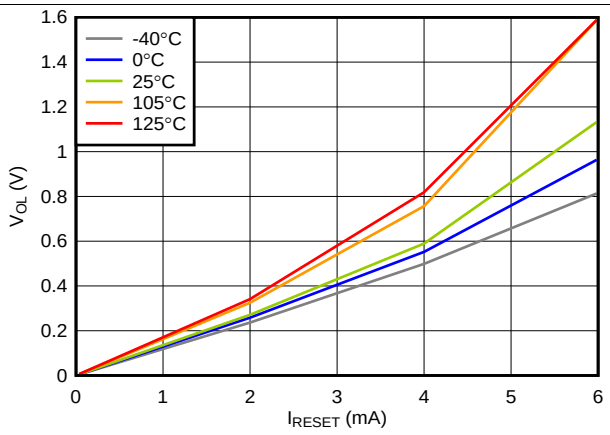
Includes G and H versions with 3.3-V nominal monitored voltage, total units = 15,536

図 9. V_{ITN} Accuracy Histogram



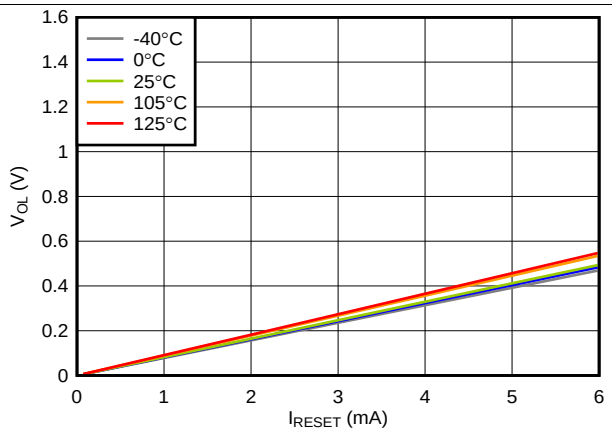
Includes G and H versions with 3.3-V nominal monitored voltage, total units = 15,536

図 10. Hysteresis Histogram



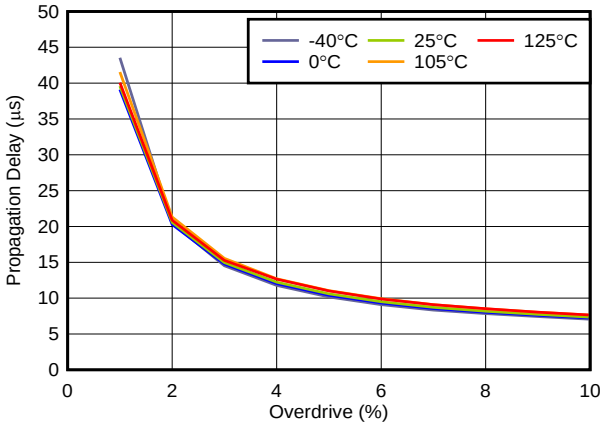
VDD = 1.6 V

図 11. Low-Level $\overline{\text{RESET}}$ Voltage vs $\overline{\text{RESET}}$ Current



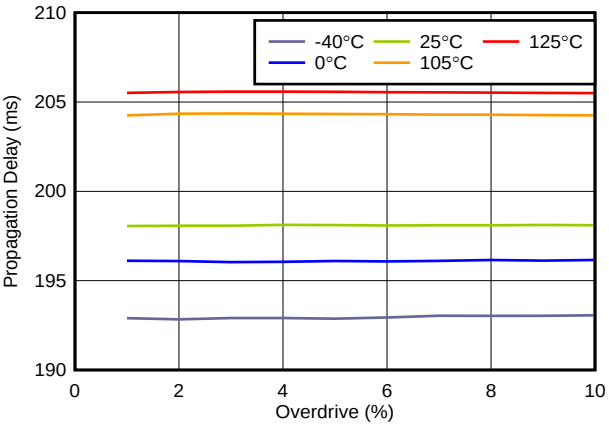
VDD = 6.5 V

図 12. Low-Level $\overline{\text{RESET}}$ Voltage vs $\overline{\text{RESET}}$ Current



TPS3852G33-Q1 entering undervoltage

図 13. Propagation Delay vs Overdrive



TPS3852G33-Q1 exiting undervoltage

図 14. Propagation Delay (t_{RST}) vs Overdrive

Typical Characteristics (continued)

all curves are taken at 25°C with 1.6 V ≤ VDD ≤ 6.5 V (unless otherwise noted)

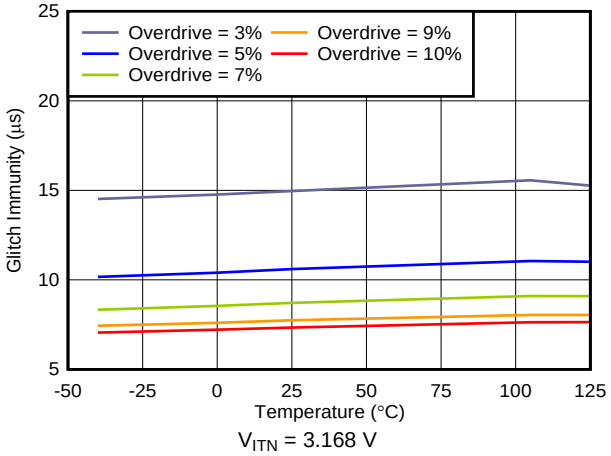


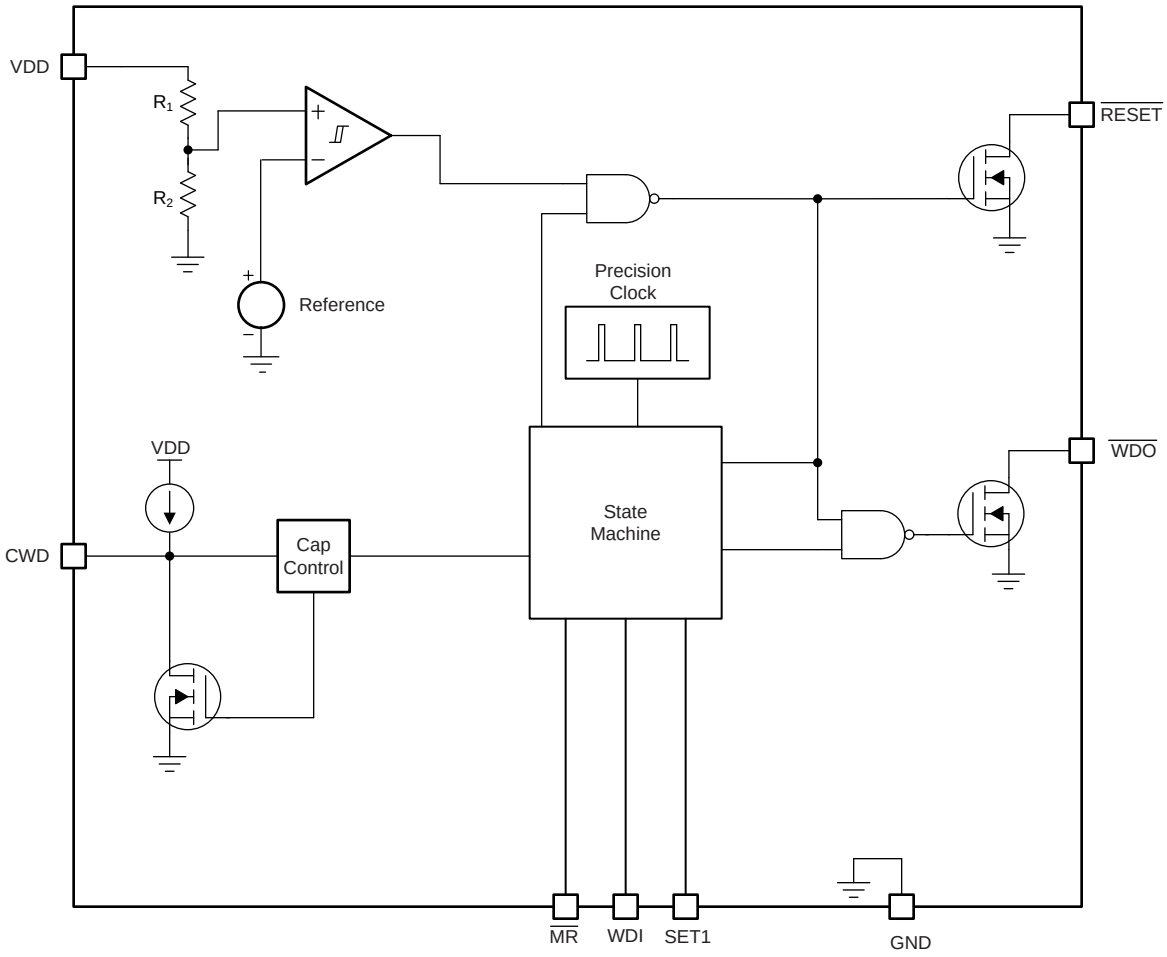
図 15. High-to-Low Glitch Immunity vs Temperature

7 Detailed Description

7.1 Overview

The TPS3852-Q1 is a high-accuracy voltage supervisor with an integrated window watchdog timer. This device includes a precision undervoltage supervisor with a threshold that achieves 0.8% accuracy over the specified temperature range of –40°C to +125°C. In addition, the TPS3852-Q1 includes accurate hysteresis on the threshold, making the device ideal for use with tight tolerance systems where voltage supervisors must ensure a $\overline{\text{RESET}}$ before the minimum supply tolerance of the microprocessor or system-on-a-chip (SoC) is reached.

7.2 Functional Block Diagram



NOTE: $R_1 + R_2 = 4.5\ M\Omega$.

7.3 Feature Description

7.3.1 $\overline{\text{RESET}}$

Connect $\overline{\text{RESET}}$ to V_{PU} through a 1-kΩ to 100-kΩ pullup resistor. $\overline{\text{RESET}}$ remains high (deasserted) when V_{DD} is greater than the negative threshold voltage (V_{ITN}). If V_{DD} falls below the negative threshold (V_{ITN}), then $\overline{\text{RESET}}$ is asserted, driving the $\overline{\text{RESET}}$ pin to low impedance. When V_{DD} rises above V_{ITN} + V_{HYST}, a delay circuit is enabled that holds $\overline{\text{RESET}}$ low for a specified reset delay period (t_{RST}). When the reset delay has elapsed, the $\overline{\text{RESET}}$ pin goes to a high-impedance state and uses a pullup resistor to hold $\overline{\text{RESET}}$ high. The pullup resistor must be connected to the desired voltage rail to allow other devices to be connected at the correct interface voltage. To ensure proper voltage levels, give some consideration when choosing the pullup resistor values. The pullup resistor value is determined by output logic low voltage (V_{OL}), leakage current (I_D), and the current through the $\overline{\text{RESET}}$ pin $I_{\overline{\text{RESET}}}$.

7.3.2 Manual Reset ($\overline{\text{MR}}$)

The manual reset ($\overline{\text{MR}}$) input allows a processor or other logic circuits to initiate a reset. A logic low on $\overline{\text{MR}}$ causes $\overline{\text{RESET}}$ to assert. After $\overline{\text{MR}}$ returns to a logic high and V_{DD} is above V_{ITN} + V_{HYST}, $\overline{\text{RESET}}$ is deasserted after the reset delay time (t_{RST}). If $\overline{\text{MR}}$ is not controlled externally, then $\overline{\text{MR}}$ can either be connected to V_{DD} or left floating because the $\overline{\text{MR}}$ pin is internally pulled up. When $\overline{\text{MR}}$ is asserted, the watchdog is disabled and all signals input to WDI are ignored.

7.3.3 Undervoltage Fault Detection

The TPS3852-Q1 features undervoltage detection for common rails between 1.8 V and 5 V. The voltage is monitored on the input rail of the device. If V_{DD} drops below V_{ITN}, then $\overline{\text{RESET}}$ is asserted (driven low). When V_{DD} is above V_{ITN} + V_{HYST}, $\overline{\text{RESET}}$ deasserts after t_{RST}, as shown in 図 16. The internal comparator has built-in hysteresis that provides some noise immunity and ensures stable operation. Although not required in most cases, for noisy applications, good analog design practice is to place a 1-nF to 100-nF bypass capacitor close to the VDD pin to reduce sensitivity to transient voltages on the monitored signal.

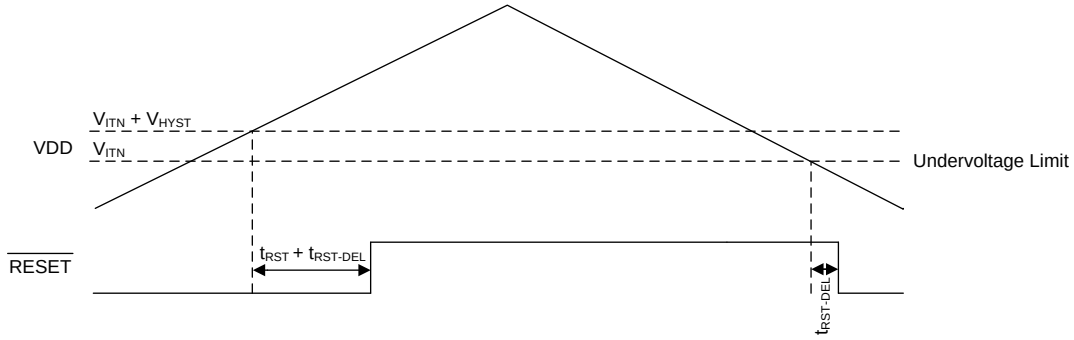


図 16. Undervoltage Detection

Feature Description (continued)

7.3.4 Watchdog Mode

This section provides information for the watchdog mode of operation.

7.3.4.1 SET1

The SET1 pin can enable and disable the watchdog timer. If SET1 is set to GND, the watchdog timer is disabled and WDI is ignored. When the watchdog is disabled, $\overline{WDO}$ is in a high-impedance state. If the watchdog timer is disabled, drive the WDI pin to either GND or VDD to ensure that there is no increase in I_{DD}. When SET1 is logic high, the watchdog operates normally. The SET1 pin can be changed dynamically; however, if the watchdog is going from disabled to enabled there is a setup time $t_{WD\text{-}setup}$ where the watchdog does not respond to changes on WDI, as shown in 図 17.

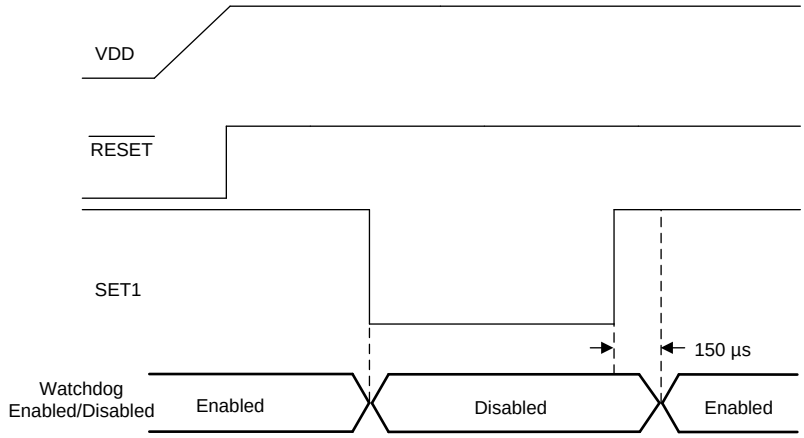


図 17. Enabling and Disabling the Watchdog

7.3.4.2 Window Watchdog Timer

This section provides information for the window watchdog mode of operation. A window watchdog is typically employed in safety-critical applications where a traditional watchdog timer is inadequate. In a traditional watchdog there is a maximum time in which a pulse must be issued to prevent the reset from occurring. In a window watchdog, the pulse must be issued between a maximum lower window time ($t_{WDL(max)}$) and the minimum upper window time ($t_{WDU(min)}$) set by the CWD pin.

7.3.4.3 Watchdog Input (WDI)

WDI is the watchdog timer input that controls the $\overline{WDO}$ output. The WDI input is triggered by the falling edge of the input signal. For the first pulse, the watchdog acts as a traditional watchdog timer; thus, the first pulse must be issued before $t_{WDU(min)}$. After the first pulse, to ensure proper functionality of the watchdog timer, always issue the WDI pulse within the window of $t_{WDL(max)}$ and $t_{WDU(min)}$. If the pulse is issued in this region, then $\overline{WDO}$ remains unasserted. Otherwise the device asserts $\overline{WDO}$, putting the $\overline{WDO}$ pin into a low-impedance state.

The watchdog input (WDI) is a digital pin. In order to ensure there is no increase in I_{DD}, drive the WDI pin to either VDD or GND at all times. Putting the pin to an intermediate voltage can cause an increase in supply current (I_{DD}) because of the architecture of the digital logic gates. When $\overline{RESET}$ is asserted, the watchdog is disabled and all signals input to WDI are ignored. When $\overline{RESET}$ is no longer asserted, the device resumes normal operation and no longer ignores the signal on WDI. If the watchdog is disabled, drive the WDI pin to either VDD or GND.

Feature Description (continued)

7.3.4.4 CWD

The CWD pin provides the functionality of both high-precision, factory-programmed window watchdog timing options and user-programmable window watchdog timing. The CWD pin can be either pulled up to V_{DD} through a resistor, have an external capacitor to ground, or be left floating. Every time that the device issues a reset event and the supply voltage is above V_{ITN}, the device tries to determine which of these three options is connected to the pin. There is an internal state machine that the device goes through to determine which option is connected to the CWD pin. The state machine can take up to 381 μs to determine if the CWD pin is left floating, pulled-up through a resistor, or connected to a capacitor.

If the CWD pin is being pulled up to V_{DD} using a pullup resistor, then use a 10-kΩ resistor.

7.3.4.5 Watchdog Output ($\overline{WDO}$)

The TPS3852-Q1 features a window watchdog with an independent watchdog output ($\overline{WDO}$). The independent watchdog output gives the flexibility to flag when there is a fault in the watchdog timing without performing an entire system reset. For legacy applications, $\overline{WDO}$ can be tied to $\overline{RESET}$. When the $\overline{RESET}$ output is not asserted, the $\overline{WDO}$ signal maintains normal operation. However, when the $\overline{RESET}$ signal is asserted, the $\overline{WDO}$ pin goes to a high-impedance state. This is due to using the standard $\overline{RESET}$ timing options when a fault occurs on $\overline{WDO}$. When $\overline{RESET}$ is unasserted, the window watchdog timer resumes normal operation.

7.4 Device Functional Modes

表 1 summarises the functional modes of the TPS3852-Q1.

表 1. Device Functional Modes

V_{DD}	WDI	$\overline{WDO}$	$\overline{RESET}$
$V_{DD} < V_{POR}$	—	—	Undefined
$V_{POR} \le V_{DD} < V_{DD(min)}$	Ignored	High	Low
$V_{DD(min)} \le V_{DD} \le V_{ITN} + V_{HYST}$ (1)	Ignored	High	Low
$V_{DD} > V_{ITN}$ (2)	$t_{WDL(max)} < t_{PULSE} < t_{WDU(min)}$ (3)	High	High
	$t_{PULSE} > t_{WDU(min)}$ (3)	Low	High
	$t_{PULSE} < t_{WDL(max)}$ (3)	Low	High

(1) Only valid before V_{DD} goes above $V_{ITN} + V_{HYST}$.
(2) Only valid after V_{DD} goes above $V_{ITN} + V_{HYST}$.
(3) Where t_{PULSE} is the time between the falling edges on WDI.

7.4.1 V_{DD} is Below V_{POR} ($V_{DD} < V_{POR}$)

When V_{DD} is less than V_{POR}, $\overline{RESET}$ is undefined and can be either high or low. The state of $\overline{RESET}$ largely depends on the load that the $\overline{RESET}$ pin is experiencing.

7.4.2 Above Power-On-Reset, But Less Than $V_{DD(min)}$ ($V_{POR} \le V_{DD} < V_{DD(min)}$)

When the voltage on V_{DD} is less than $V_{DD(min)}$ and greater than or equal to V_{POR}, the $\overline{RESET}$ signal is asserted (logic low). When $\overline{RESET}$ is asserted, the watchdog output $\overline{WDO}$ is in a high-impedance state regardless of the WDI signal that is input to the device.

7.4.3 Normal Operation ($V_{DD} \ge V_{DD(min)}$)

When V_{DD} is greater than or equal to $V_{DD(min)}$, the $\overline{RESET}$ signal is determined by V_{DD}. When $\overline{RESET}$ is asserted, $\overline{WDO}$ goes to a high-impedance state. $\overline{WDO}$ is then pulled high through the pullup resistor.

8 Application and Implementation

注

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

8.1 Application Information

8.1.1 CWD Functionality

The TPS3852-Q1 features three options for setting the watchdog window: connecting a capacitor to the CWD pin, connecting a pullup resistor to VDD, and leaving the CWD pin unconnected. 図 18 shows a schematic drawing of all three options. If this pin is connected to VDD through a 10-kΩ pullup resistor or left unconnected (high impedance), then the factory-programmed watchdog timeouts are enabled; see the *Timing Requirements* table. Otherwise, the watchdog timeout can be adjusted by placing a capacitor from the CWD pin to ground.

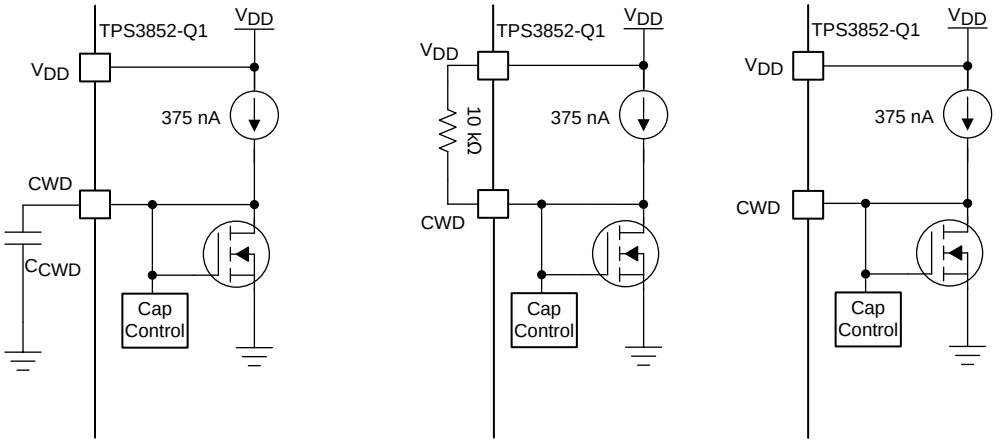


図 18. CWD Charging Circuit

8.1.1.1 Factory-Programmed Timing Options

If using the factory-programmed timing options (listed in 表 2), the CWD pin must either be unconnected or pulled up to VDD through a 10-kΩ pullup resistor. Using these options enables high-precision watchdog timing.

表 2. Factory-Programmed Watchdog Timing

INPUT		WATCHDOG LOWER BOUNDARY (t_{WDL})			WATCHDOG UPPER BOUNDARY (t_{WDU})			UNIT
CWD	SET1	MIN	TYP	MAX	MIN	TYP	MAX	
NC	0	Watchdog disabled			Watchdog disabled			
	1	680	800	920	1360	1600	1840	ms
10 kΩ to VDD	0	Watchdog disabled			Watchdog disabled			
	1	1.48	1.85	2.22	9.35	11.0	12.65	ms

8.1.1.2 Adjustable Capacitor Timing

Adjustable capacitor timing is achievable by connecting a capacitor to the CWD pin. If a capacitor is connected to CWD, then a 375-nA current source charges C_{CWD} until V_{CWD} = 1.21 V. The TPS3852-Q1 determines the window watchdog upper boundary with the formula given in 式 1, where C_{CWD} is in microfarads (µF) and t_{WDU} is in seconds.

$$t_{WDU(typ)}(s) = 77.4 \times C_{CWD}(\mu F) + 0.055\ (s) \quad (1)$$

The TPS3852-Q1 is limited to using C_{CWD} capacitors between 100 pF and 1 µF. Note that 式 1 is for ideal capacitors; capacitor tolerances cause the actual device timing to vary. For the most accurate timing, use ceramic capacitors with COG dielectric material. As shown in 表 3, when using the minimum capacitance of 100 pF, the watchdog upper boundary is 62.74 ms; whereas with a 1-µF capacitance, the watchdog upper boundary is 77.455 seconds. If a C_{CWD} capacitor is used, 式 1 can be used to set the window watchdog upper boundary (t_{WDU}). 表 4 shows how t_{WDU} can be used to calculate t_{WDL}.

表 3. t_{WDU} Values for Common Ideal Capacitor Values

C_{CWD}	WATCHDOG UPPER BOUNDARY (t_{WDU})			UNIT
	MIN(1)	TYP	MAX(1)	
100 pF	53.32	62.74	72.15	ms
1 nF	112.5	132.4	152.2	ms
10 nF	704	829	953	ms
100 nF	6625	7795	8964	ms
1 µF	65836	77455	89073	ms

(1) Minimum and maximum values are calculated using ideal capacitors.

表 4. Programmable CWD Timing

INPUT		WATCHDOG LOWER BOUNDARY (t_{WDL})			WATCHDOG UPPER BOUNDARY (t_{WDU})			UNIT
CWD	SET1	MIN	TYP	MAX	MIN	TYP	MAX	
C_{CWD}	0	Watchdog disabled			Watchdog disabled			
	1	$t_{WDU(min)}$ x 0.5	t_{WDU} x 0.5	$t_{WDU(max)}$ x 0.5	0.85 x $t_{WDU(typ)}$	$t_{WDU(typ)}$(1)	1.15 x $t_{WDU(typ)}$	s

(1) Calculated from 式 1 using ideal capacitors.

8.1.2 Overdrive Voltage

Forcing a $\overline{\text{RESET}}$ is dependent on two conditions: the amplitude V_{DD} is beyond the trip point (ΔV_1 and ΔV_2), and the length of time that the voltage is beyond the trip point (t_1 and t_2). If the voltage is just under the trip point for a long period of time, $\overline{\text{RESET}}$ asserts and the output is pulled low. However, if V_{DD} is just under the trip point for a few nanoseconds, $\overline{\text{RESET}}$ does not assert and the output remains high. The length of time required for $\overline{\text{RESET}}$ to assert can be changed by increasing the amount V_{DD} goes under the trip point. If V_{DD} is under the trip point by 10%, the amount of time required for the comparator to respond is much faster and causes $\overline{\text{RESET}}$ to assert much quicker than when barely under the trip point voltage. 式 2 shows how to calculate the percentage overdrive.

$$\text{Overdrive} = |(V_{DD} / V_{ITX} - 1) \times 100\% | \quad (2)$$

In 式 2, V_{ITX} corresponds to the threshold trip point. If V_{DD} is exceeding the positive threshold, $V_{ITN} + V_{HYST}$ is used. V_{ITN} is used when V_{DD} is falling below the negative threshold. In 図 19, t_1 and t_2 correspond to the amount of time that V_{DD} is over the threshold; the propagation delay versus overdrive for V_{ITN} and $V_{ITN} + V_{HYST}$ is illustrated in 図 13 and 図 14, respectively.

The TPS3852-Q1 is relatively immune to short positive and negative transients on VDD because of the overdrive voltage.

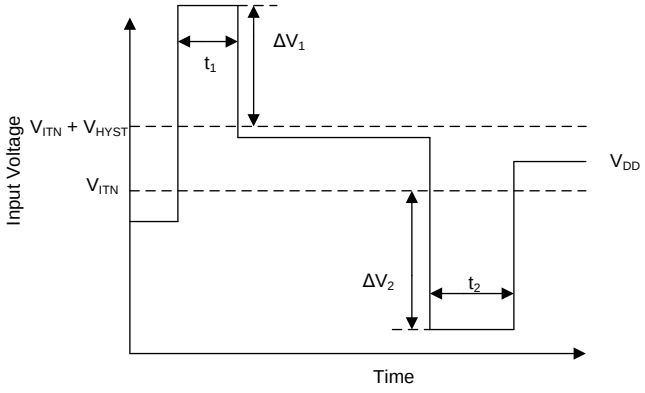


図 19. Overdrive Voltage

8.2 Typical Application

A typical application for the TPS3852-Q1 is shown in 図 20. The TPS3852G33-Q1 is used to monitor the 3.3-V, V_{CORE} rail powering the microcontroller.

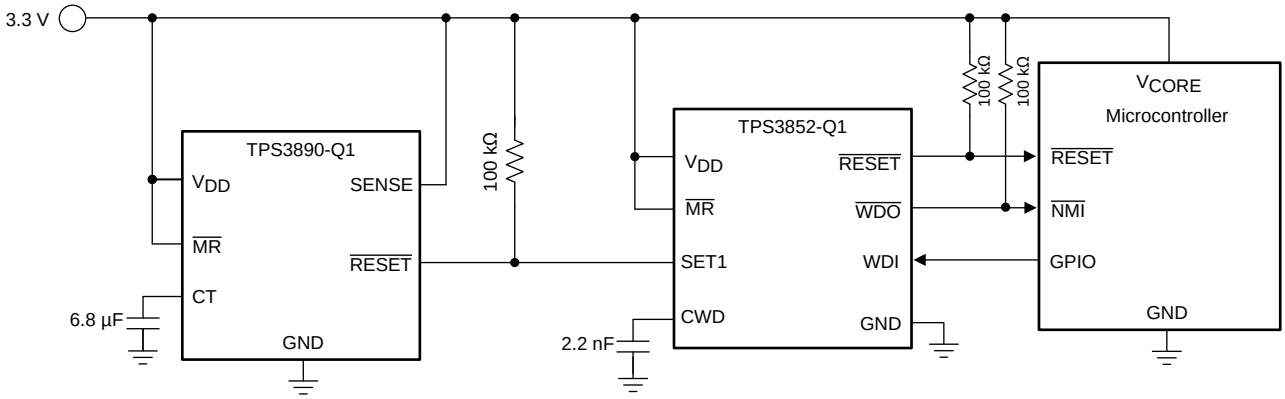


図 20. Monitoring Supply Voltage and Watchdog Supervision of a Microcontroller

8.2.1 Design Requirements

PARAMETER	DESIGN REQUIREMENT	DESIGN RESULT
Watchdog disable for initialization period	Watchdog must remain disabled for 7 seconds until logic enables the watchdog timer	7.21 seconds (typ)
Output logic voltage	3.3-V CMOS	3.3-V CMOS
Monitored rail	3.3 V with a 5% threshold	Worst-case V_{ITN} = 3.142 V (–4.7% threshold)
Watchdog window	250 ms, maximum	$t_{WDL(max)}$ = 135 ms, $t_{WDU(min)}$ = 181 ms
Maximum device current consumption	50 µA	52 µA (worst-case) when $\overline{RESET}$ or $\overline{WDO}$ is asserted(1)

(1) Only includes the TPS3852G33-Q1 current consumption.

8.2.2 Detailed Design Procedure

8.2.2.1 Monitoring the 3.3-V Rail

This application calls for very tight monitoring of the rail with only 5% of variation allowed on the rail. To ensure this requirement is met, the TPS3852G33-Q1 was chosen for its –4% threshold. To calculate the worst-case for V_{ITN}, the accuracy must also be taken into account. The worst-case for V_{ITN} can be calculated by 式 3:

$$V_{ITN(Worst\text{-}Case)} = V_{ITN(typ)} \times 0.992 = 3.3 \times 0.96 \times 0.992 = 3.142\ V \quad (3)$$

8.2.2.2 Calculating $\overline{\text{RESET}}$ and the $\overline{\text{WDO}}$ Pullup Resistor

The TPS3852-Q1 uses an open-drain configuration for the $\overline{\text{RESET}}$ circuit, as shown in 図 21. When the FET is off, the resistor pulls the drain of the transistor to VDD and when the FET is turned on, the FET attempts to pull the drain to ground, thus creating an effective resistor divider. The resistors in this divider must be chosen to ensure that V_{OL} is below the maximum value. To choose the proper pullup resistor, there are three key specifications to keep in mind: the pullup voltage (V_{PU}), the recommended maximum $\overline{\text{RESET}}$ pin current ($I_{\overline{\text{RESET}}}$), and V_{OL}. The maximum V_{OL} is 0.4 V, meaning that the effective resistor divider created must be able to bring the voltage on the reset pin below 0.4 V with $I_{\overline{\text{RESET}}}$ kept below 10 mA. For this example, with a V_{PU} of 3.3 V, a resistor must be chosen to keep $I_{\overline{\text{RESET}}}$ below 50 μA because this value is the maximum consumption current allowed. To ensure this specification is met, a pullup resistor value of 100 kΩ was selected, which sinks a maximum of 33 μA when $\overline{\text{RESET}}$ or $\overline{\text{WDO}}$ is asserted. As illustrated in 図 11, when the $\overline{\text{RESET}}$ current is at 33 μA the low-level output voltage is approximately zero.

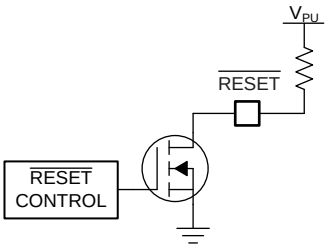


図 21. $\overline{\text{RESET}}$ Open-Drain Configuration

8.2.2.3 Setting the Window Watchdog

As illustrated in 図 18, there are three options for setting the window watchdog. The design specifications in this application require the programmable timing option (external capacitor connected to CWD). When a capacitor is connected to the CWD pin, the window is governed by 式 4. 式 4 is only valid for ideal capacitors, any temperature or voltage derating must be accounted for separately.

$$C_{CWD}\left(\mu F\right) = \frac{t_{WDU} - 0.055}{77.4} = \frac{0.25 - 0.055}{77.4} = 0.0025\ \mu F \tag{4}$$

The nearest standard capacitor value to 2.5 nF is 2.2 nF. Selecting 2.2 nF for the C_{CWD} capacitor gives the following minimum and maximum timing parameters:

$$t_{WDU(MIN)} = 0.85 \times t_{WDU(TYP)} = 0.85 \times \left(77.4 \times 2.2 \times 10^{-3} + 0.055\right) = 191\ ms \tag{5}$$

$$t_{WDL(MAX)} = 0.5 \times t_{WDU(MAX)} = 0.5 \times \left[1.15 \times \left(77.4 \times 2.2 \times 10^{-3} + 0.055\right)\right] = 129\ ms \tag{6}$$

Capacitor tolerance also influence $t_{WDU(MIN)}$ and $t_{WDL(MAX)}$. Select a ceramic COG dielectric capacitor for high accuracy. For 2.2 nF, COG capacitors are readily available with a 5% tolerance, which results in a 5% decrease in $t_{WDU(MIN)}$ and a 5% increase in $t_{WDL(MAX)}$, giving 181 ms and 135 ms, respectively. A falling edge must be issued within this window.

8.2.2.4 Watchdog Disabled During Initialization Period

The watchdog is often needed to be disabled during startup to allow for an initialization period. When the initialization period is over, the watchdog timer is turned back on to allow the microcontroller to be monitored by the TPS3852-Q1. To achieve this setup, SET1 must start at GND. In this design, SET1 is controlled by a TPS3890-Q1 supervisor. In this application, the TPS3890-Q1 was chosen to monitor V_{DD} as well, meaning that $\overline{\text{RESET}}$ on the TPS3890-Q1 stays low until V_{DD} rises above V_{ITN}. When V_{DD} comes up, the delay time can be adjusted through the CT capacitor on the TPS3890-Q1. With this approach, the $\overline{\text{RESET}}$ delay can be adjusted from a minimum of 25 μs to a maximum of 30 seconds. For this design, a minimum delay of 7 seconds is needed until the watchdog timer is enabled. The CT capacitor calculation (see the TPS3890-Q1 data sheet) yields an ideal capacitance of 6.59 μF, giving a closest standard ceramic capacitor value of 6.8 μF. When connecting a 6.8-μF capacitor from CT to GND, the typical delay time is 7.21 seconds. 図 22 illustrates the typical startup waveform for this circuit when the watchdog input is off. 図 22 illustrates that when the watchdog is disabled, the $\overline{\text{WDO}}$ output remains high. See the TPS3890-Q1 data sheet for detailed information on the TPS3890-Q1.

8.2.3 Glitch Immunity

図 25 shows the high-to-low glitch immunity for the TPS3852G33-Q1 with a 7% overdrive with V_{DD} starting at 3.3 V. This curve shows that V_{DD} can go below the threshold for 5.2 µs without $\overline{\text{RESET}}$ asserting.

8.2.4 Application Curves

Unless otherwise stated, application curves were taken at T_A = 25°C.

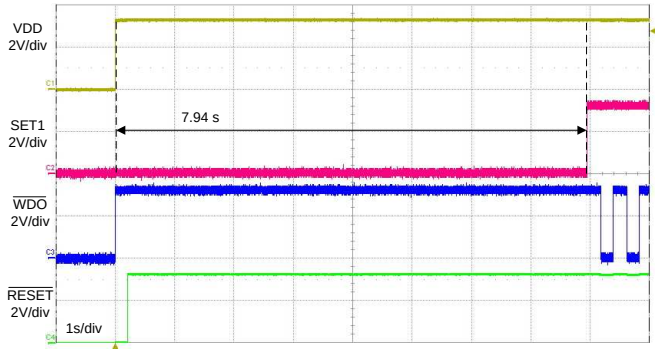


図 22. Startup Without a WDI Signal

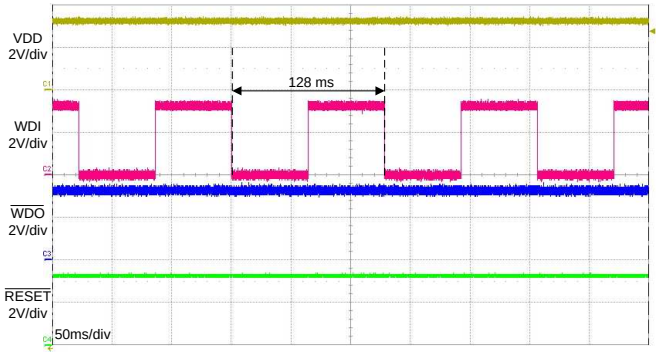


図 23. Typical WDI Signal

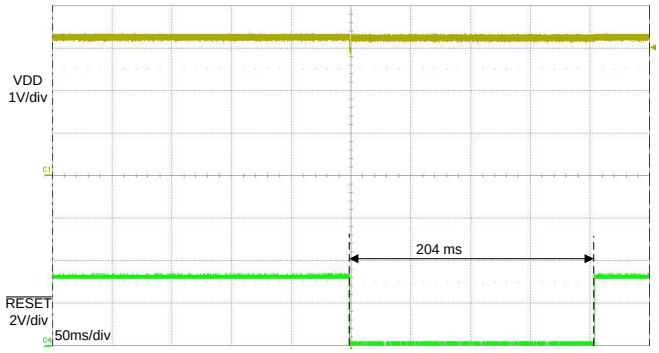


図 24. Typical $\overline{\text{RESET}}$ Delay

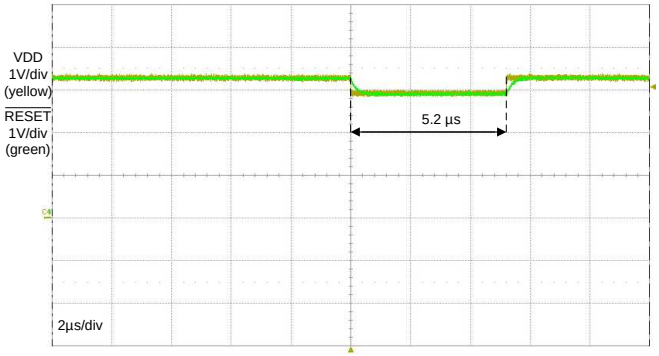


図 25. High-to-Low Glitch Immunity

9 Power Supply Recommendations

This device is designed to operate from an input supply with a voltage range between 1.6 V and 6.5 V. An input supply capacitor is not required for this device; however, if the input supply is noisy, then good analog practice is to place a 0.1-µF capacitor between the VDD pin and the GND pin.

10 Layout

10.1 Layout Guidelines

- Make sure that the connection to the VDD pin is low impedance. Good analog design practice is to place a 0.1-µF ceramic capacitor as near as possible to the VDD pin.
- If a C_{CWD} capacitor or pull-up resistor is used, place these components as close as possible to the CWD pin. If the CWD pin is left unconnected, make sure to minimize the amount of parasitic capacitance on the pin.
- Place the pullup resistors on $\overline{\text{RESET}}$ and $\overline{\text{WDO}}$ as close to the pin as possible.

10.2 Layout Example

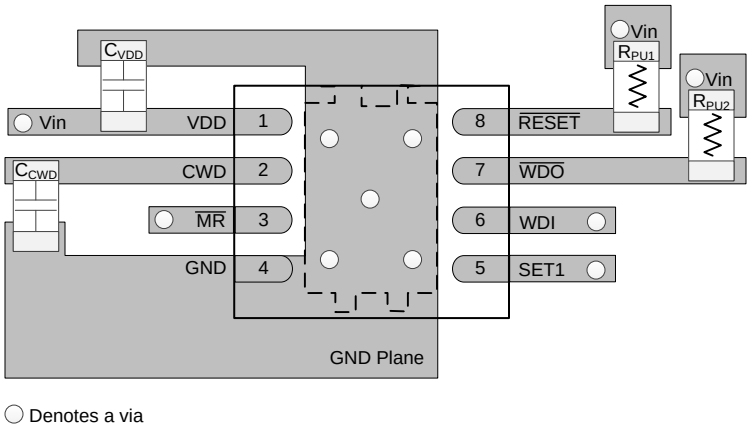


図 26. Typical Layout for the TPS3852-Q1

11 デバイスおよびドキュメントのサポート

11.1 デバイス・サポート

11.1.1 開発サポート

11.1.1.1 評価モジュール

*TPS3851EVM-780評価モジュール*は、この部品の評価に使用できます。この評価モジュールを使用する場合、EVM上のデバイスをTPS3852-Q1に変更する必要があります。

11.1.2 デバイスの項目表記

表 5. デバイスの項目表記

説明	項目表記	値
TPS3852 (ウィンドウ・ウォッチドッグ付きの高精度スーパバイザ)	—	—
X (公称スレッショルド: 監視対象の公称電圧の百分率)	G	V_{ITN} = -4%
	H	V_{ITN} = -7%
yy(y)(1) (監視対象の公称電圧のオプション)	18	1.8V
	33	3.3V

(1) たとえば、TPS3852G33QDRBQ1は監視対象の公称電圧3.3V、公称スレッショルド-4%を意味します。

11.2 ドキュメントの更新通知を受け取る方法

ドキュメントの更新についての通知を受け取るには、ti.comのデバイス製品フォルダを開いてください。右上の隅にある「*通知を受け取る*」をクリックして登録すると、変更されたすべての製品情報に関するダイジェストを毎週受け取れます。変更の詳細については、修正されたドキュメントに含まれている改訂履歴をご覧ください。

11.3 コミュニティ・リソース

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

TI E2E™オンライン・コミュニティ ***TIのE2E (Engineer-to-Engineer) コミュニティ。エンジニア間の共同作業を促進するために開設されたものです。e2e.ti.comでは、他のエンジニアに質問し、知識を共有し、アイディアを検討して、問題解決に役立てることができます。***

設計サポート ***TIの設計サポート*** **役に立つE2Eフォーラムや、設計サポート・ツールをすばやく見つけることができます。技術サポート用の連絡先情報も参照できます。**

11.4 商標

E2E is a trademark of Texas Instruments.
All other trademarks are the property of their respective owners.

11.5 静電気放電に関する注意事項

すべての集積回路は、適切なESD保護方法を用いて、取扱いと保存を行うようにして下さい。

静電気放電はわずかな性能の低下から完全なデバイスの故障に至るまで、様々な損傷を与えます。高精度の集積回路は、損傷に対して敏感であり、極めてわずかなパラメータの変化により、デバイスに規定された仕様に適合しなくなる場合があります。

11.6 Glossary

SLYZ022 — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

12 メカニカル、パッケージ、および注文情報

以降のページには、メカニカル、パッケージ、および注文に関する情報が記載されています。この情報は、そのデバイスについて利用可能な最新のデータです。このデータは予告なく変更されることがあり、ドキュメントが改訂される場合もあります。本データシートのブラウザ版を使用されている場合は、画面左側の説明をご覧ください。

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package | Pins	Package qty | Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
TPS3852G18QDRBRQ1	Active	Production	SON (DRB) | 8	3000 | LARGE T&R	Yes	NIPDAU | SN	Level-2-260C-1 YEAR	-40 to 125	852DB
TPS3852G18QDRBRQ1.A	Active	Production	SON (DRB) | 8	3000 | LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	852DB
TPS3852G33QDRBRQ1	Active	Production	SON (DRB) | 8	3000 | LARGE T&R	Yes	NIPDAU | SN	Level-2-260C-1 YEAR	-40 to 125	852GB
TPS3852G33QDRBRQ1.A	Active	Production	SON (DRB) | 8	3000 | LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	852GB
TPS3852H18QDRBRQ1	Active	Production	SON (DRB) | 8	3000 | LARGE T&R	Yes	NIPDAU | SN	Level-2-260C-1 YEAR	-40 to 125	852LB
TPS3852H18QDRBRQ1.A	Active	Production	SON (DRB) | 8	3000 | LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	852LB
TPS3852H33QDRBRQ1	Active	Production	SON (DRB) | 8	3000 | LARGE T&R	Yes	NIPDAU | SN	Level-2-260C-1 YEAR	-40 to 125	852PB
TPS3852H33QDRBRQ1.A	Active	Production	SON (DRB) | 8	3000 | LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	852PB

(1) **Status:** For more details on status, see our product life cycle.

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF TPS3852-Q1 :

- Catalog : TPS3852

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product

GENERIC PACKAGE VIEW

DRB 8

VSON - 1 mm max height

PLASTIC SMALL OUTLINE - NO LEAD

Images above are just a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.

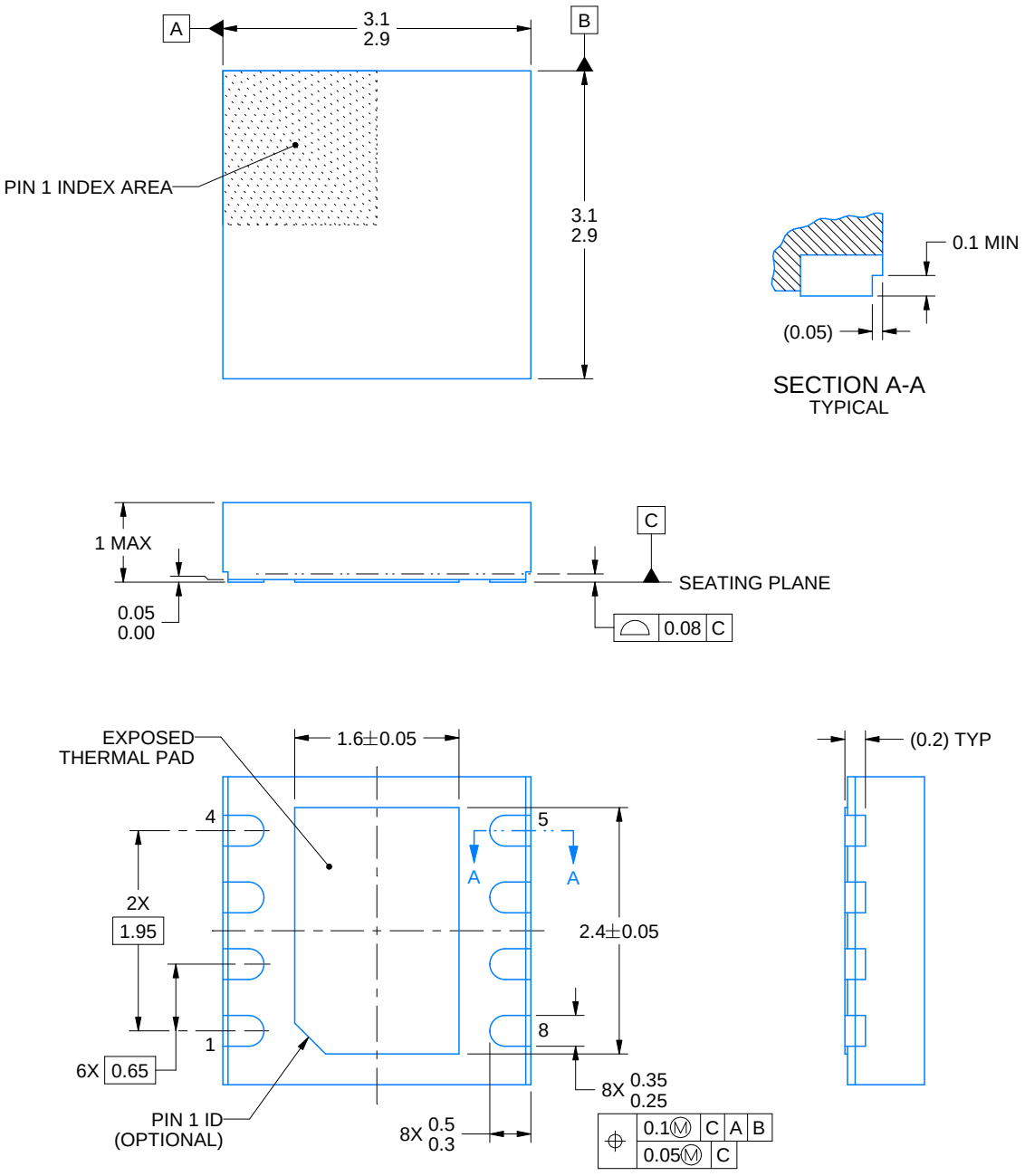
4203482/L

DRB0008F

PACKAGE OUTLINE

VSON - 1 mm max height

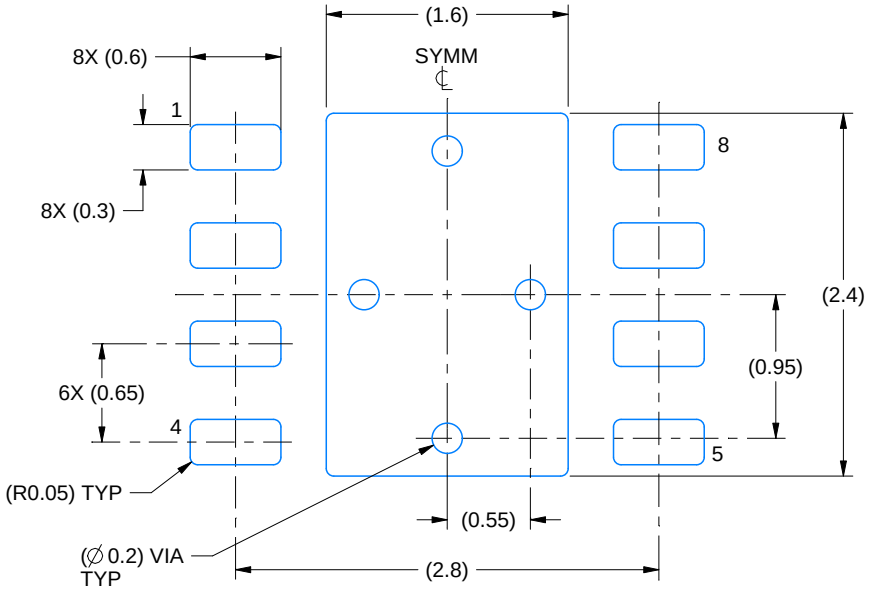
PLASTIC SMALL OUTLINE - NO LEAD



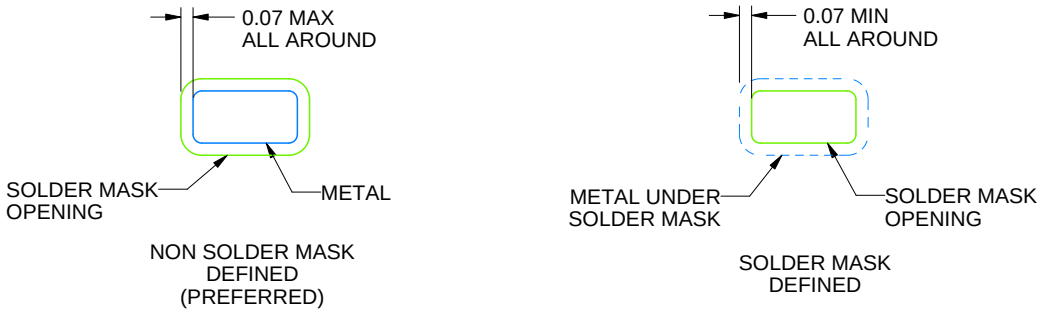
4222121/C 10/2016

NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.



LAND PATTERN EXAMPLE
SCALE:20X

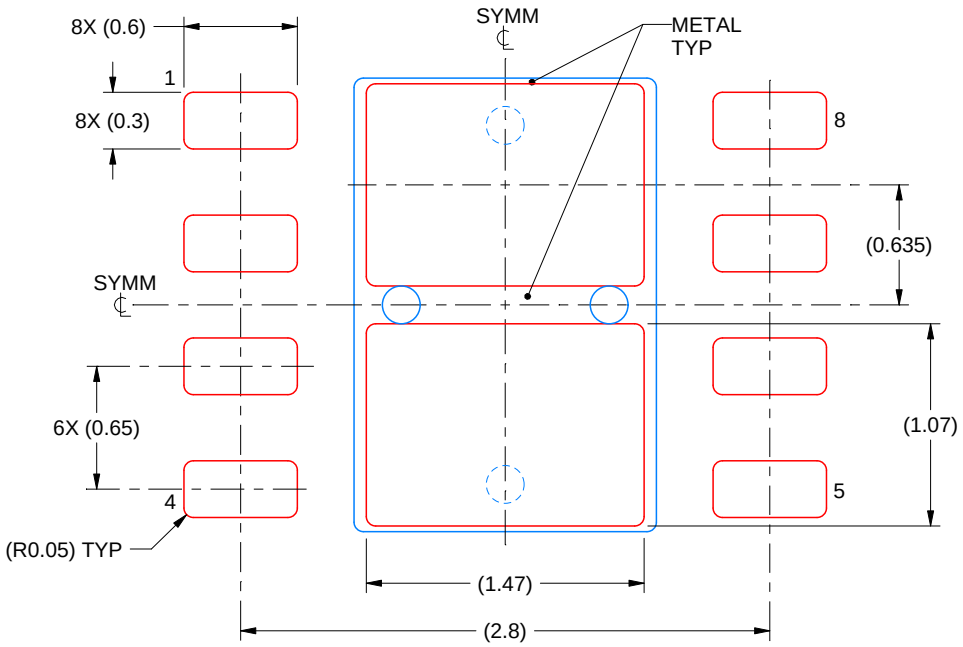


SOLDER MASK DETAILS

4222121/C 10/2016

NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD
82% PRINTED SOLDER COVERAGE BY AREA
SCALE:25X

4222121/C 10/2016

NOTES: (continued)

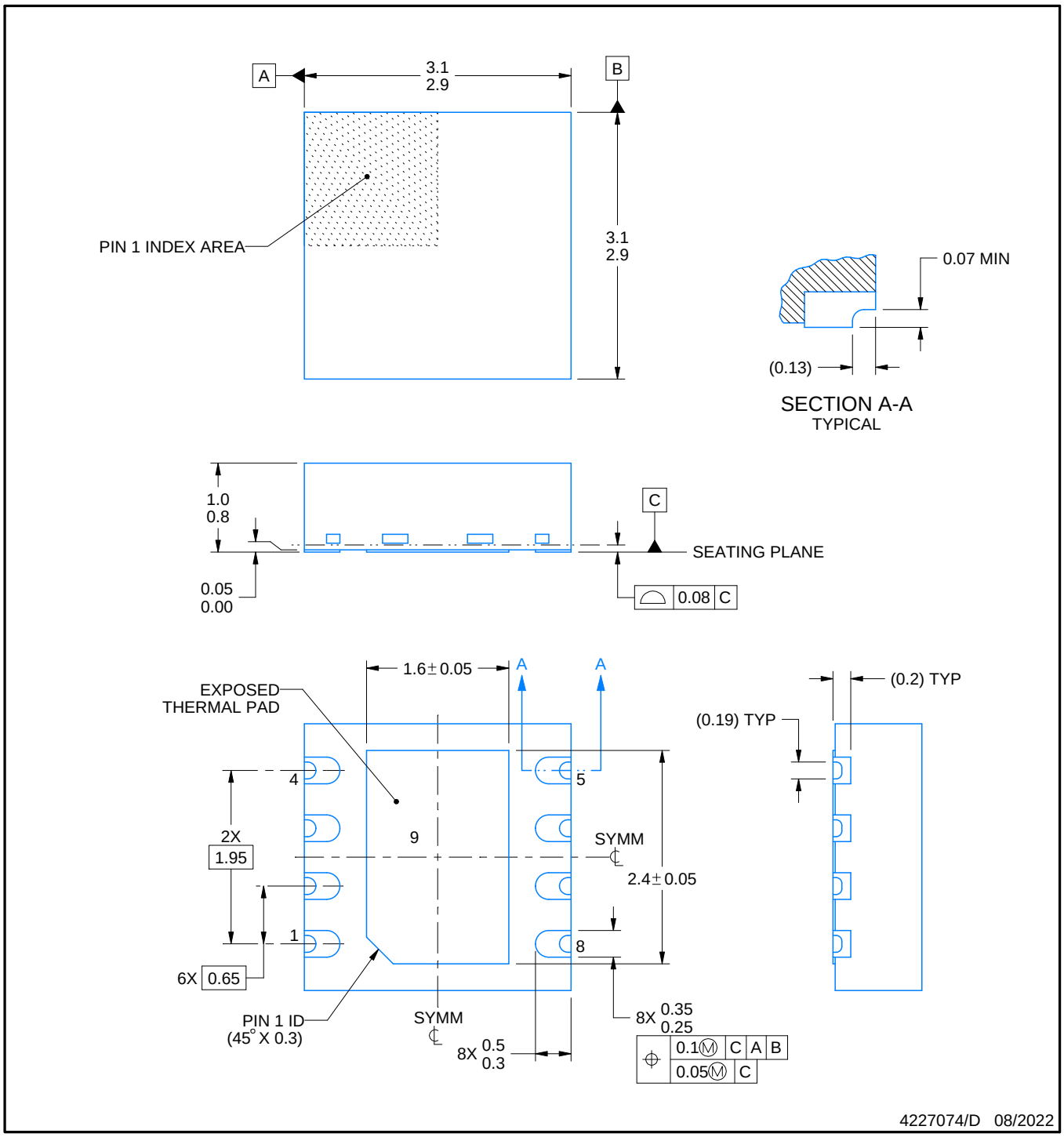
6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

DRB0008K

PACKAGE OUTLINE

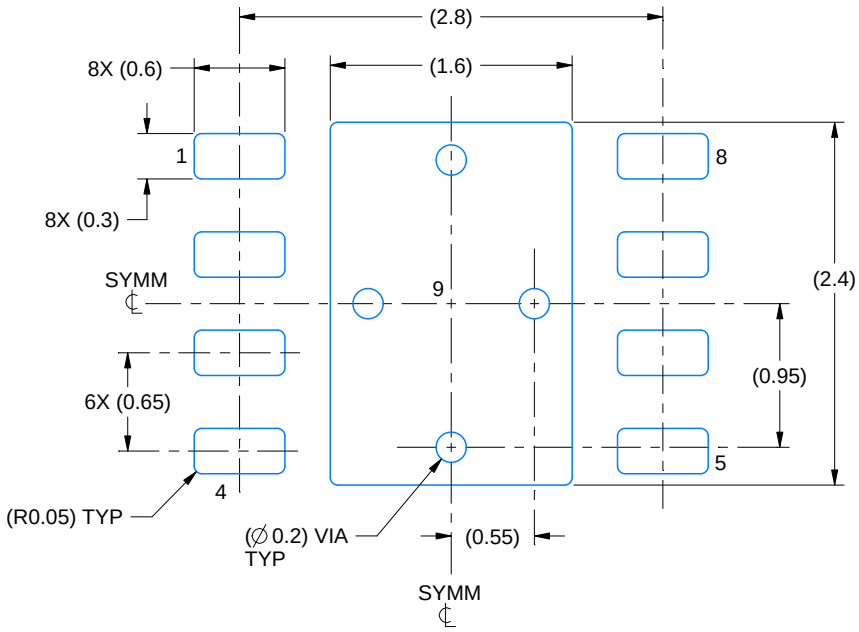
VSON - 1 mm max height

PLASTIC SMALL OUTLINE - NO LEAD

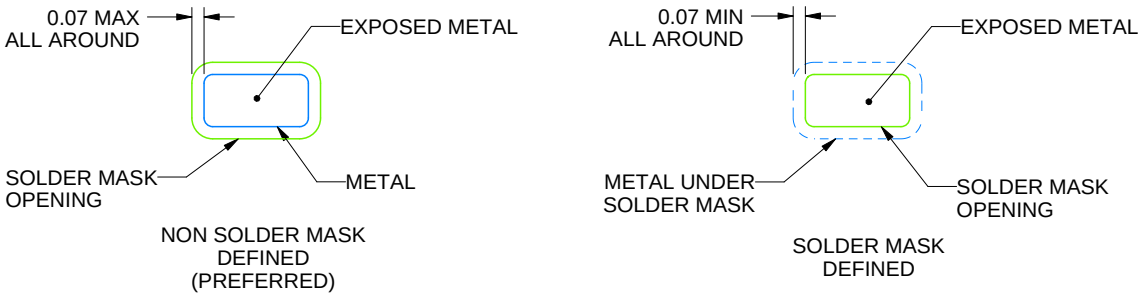


NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for optimal thermal and mechanical performance.



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:20X

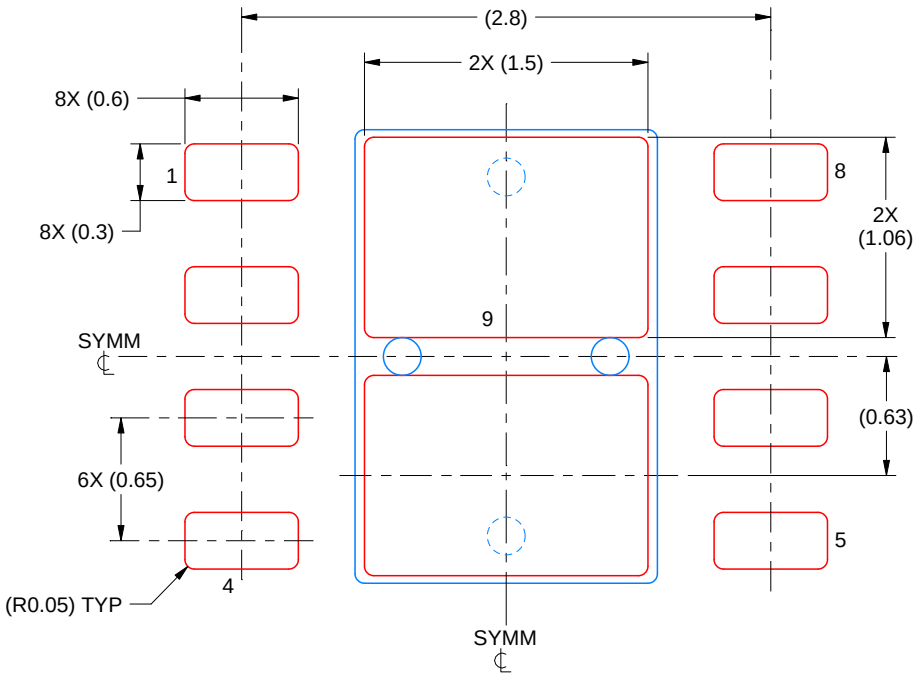


SOLDER MASK DETAILS

4227074/D 08/2022

NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD 9:
80% PRINTED SOLDER COVERAGE BY AREA
SCALE:25X

4227074/D 08/2022

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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最終更新日：2025 年 10 月